

> Mechanical Specification:

(1) Dimension

- Chip size: 8 mil x 36 mil ($200 \pm 25 \mu\text{m} \times 910 \pm 25 \mu\text{m}$)
- Thickness: 4.9 mil ($125 \pm 10 \mu\text{m}$)
- P bonding pad: 2.4 mil ($60 \pm 10 \mu\text{m}$)
- N bonding pad: 2.4 mil ($60 \pm 10 \mu\text{m}$)

(2) Metallization

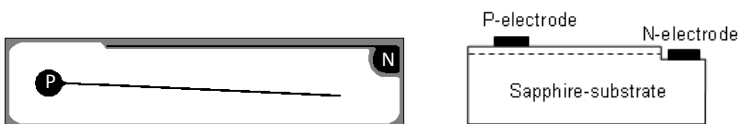
- Topside P electrode: Au alloy
- Topside N electrode: Au alloy

Features:

- High radiant flux
- 100% probing test
- Passivation layer on top
- Long operation life

Applications:

- Backlighting



> Electro-optical Characteristics at 25°C: ⁽¹⁾

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	Vf1	If = 10 μ A	2.0	-	-	V
	Vf2	If = 20mA	-	2.8	3.0	V
Reverse Current	Ir	Vr = 5V	-	-	2.0	μ A
Dominant Wavelength ⁽²⁾	λ_d	If = 20mA	445	-	465	nm
Spectra Half-width	$\Delta\lambda$	If = 20mA	-	25	-	nm
Radiant Flux ⁽³⁾⁽⁴⁾	Po	A36	40	-	42	mW
		A37	42	-	44	

Note:

(1) ESD protection during chip handling is recommended.

(2) Basically, the wavelength span is 20nm; however, customers' special requirements are also welcome.

(3) Radiant flux is determined by using an Ag-plated TO-can header without an encapsulant.

(4) Radiant flux measurement allows a tolerance of $\pm 15\%$.

> Absolute Maximum Ratings:

Parameter	Symbol	Condition	Rating	Unit
Forward DC Current	If	Ta = 25°C	≤ 60	mA
Reverse Voltage	Vr	Ta = 25°C	≤ 5	V
Junction Temperature	Tj	-	≤ 125	°C
Storage Temperature	Tstg	Chip	-40 ~ +85	°C
		Chip-on-tape/storage	5 ~ 35	°C
		Chip-on-tape/transportation	-20 ~ +65	°C
Temperature during Packaging	-	-	280(<10sec)	°C

Note: Maximum ratings are package dependent. The above maximum ratings were determined using a Printed Circuit Board (PCB) without an encapsulant. Stresses in excess of the absolute maximum ratings such as forward current and junction temperature may cause damage to the LED.

> Characteristic Curves:

Fig.1 – Relative Luminous Intensity vs. Forward Current

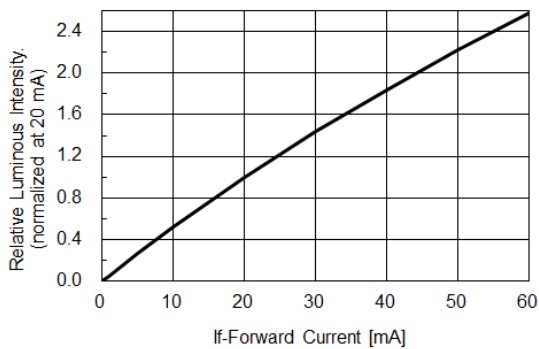


Fig.2 – Forward Current vs. Forward Voltage

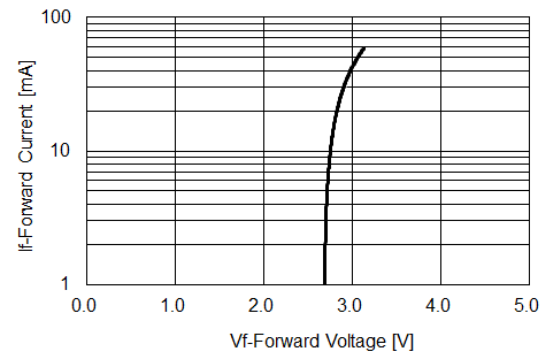


Fig.3 – Relative Intensity (@20mA) vs. Ambient Temperature

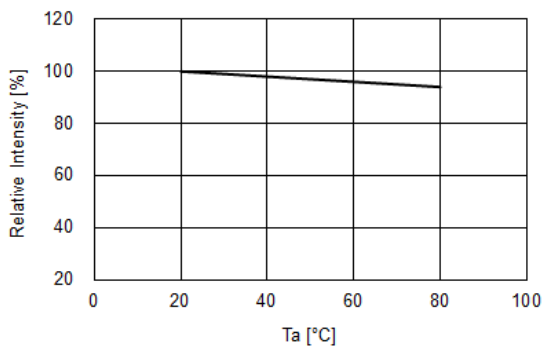


Fig.4 – Forward Voltage (@20mA) vs. Ambient Temperature

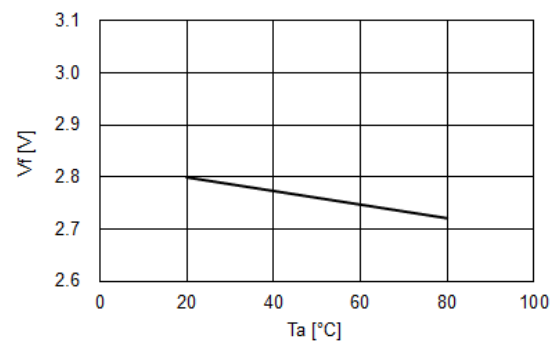


Fig.5 – Dominant Wavelength (@20mA) vs. Ambient Temperature

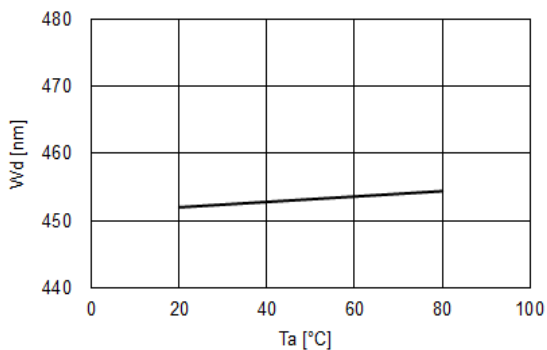


Fig.6 – Maximum Driving Forward DC Current vs. Ambient Temperature (De-rating based on Tj max. = 125°C)

